onsemi

MOSFET – Single, N-Channel

60 V, 2.5 mΩ**, 155 A**

NTD5C632NL

Features

- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

| MAXIMUM RATINGS (T _J = 25°C unless otherwise noted) | | | | | | |
|--|----------------------|---------------------------|-----------------------------------|---------------|------|--|
| Parameter | | | Symbol | Value | Unit | |
| Drain-to-Source Voltage | | | V _{DSS} | 60 | V | |
| Gate-to-Source Voltage | | | V _{GS} | ±20 | V | |
| Continuous Drain Cur- | Steady State | $T_C = 25^{\circ}C$ | I _D | 155 | А | |
| rent $R_{\theta JC}$ (Notes 1 & 3) | | $T_C = 100^{\circ}C$ | | 110 | | |
| Power Dissipation $R_{\theta JC}$ | | $T_C = 25^{\circ}C$ | PD | 115 | W | |
| (Note 1) | | $T_{C} = 100^{\circ}C$ | | 58 | | |
| Continuous Drain | Steady State | $T_A = 25^{\circ}C$ | Ι _D | 29 | А | |
| Current R _{0JA} (Notes 1, 2 & 3) | | $T_A = 100^{\circ}C$ | | 21 | | |
| Power Dissipation $R_{\theta JA}$ | | $T_A = 25^{\circ}C$ | PD | 4 | W | |
| (Notes 1 & 2) | | T _A = 100°C | | 2 | | |
| Pulsed Drain Current | T _A = 25° | C, t _p = 10 μs | I _{DM} | 900 | А | |
| Operating Junction and Storage Temperature | | | T _J , T _{stg} | -55 to 175 | °C | |
| Source Current (Body Diode) | | | I _S | 96 | А | |
| Single Pulse Drain–to–Source Avalanche Energy $(I_{L(pk)} = 14.4 \text{ A})$ | | | E _{AS} | 363 | mJ | |
| Lead Temperature for Soldering Purposes (1/8" from case for 10 s) | | | ΤL | 260 | °C | |

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

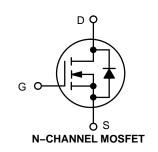
| Parameter | Symbol | Value | Unit |
|---|-----------------|-------|------|
| Junction-to-Case (Drain) (Note 1) | $R_{\theta JC}$ | 1.3 | °C/W |
| Junction-to-Ambient - Steady State (Note 2) | Reia | 37 | |

 The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
Surface, mounted on EP4 based using a 650 mm² 2 cr. Cu and

2. Surface-mounted on FR4 board using a 650 $\rm mm^2,$ 2 oz. Cu pad.

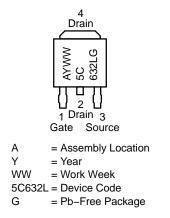
3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

| V _{(BR)DSS} | R _{DS(on)} | I _D |
|----------------------|---------------------|----------------|
| 60 V | 2.5 mΩ @ 10 V | 155 A |
| | 3.4 mΩ @ 4.5 V | 135 A |





MARKING DIAGRAM & PIN ASSIGNMENT



ORDERING INFORMATION

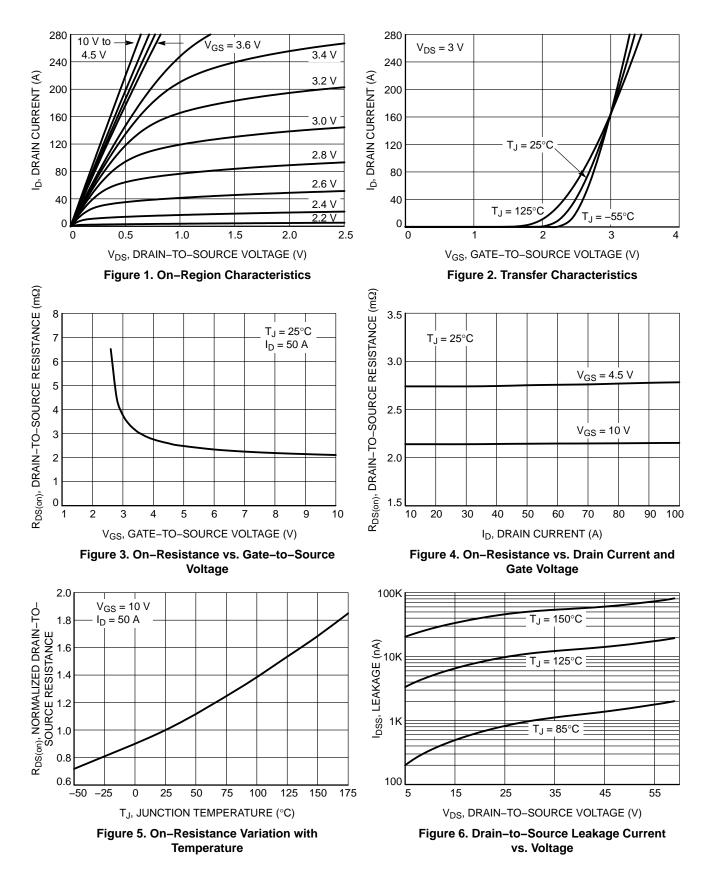
See detailed ordering and shipping information in the package dimensions section on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise noted)

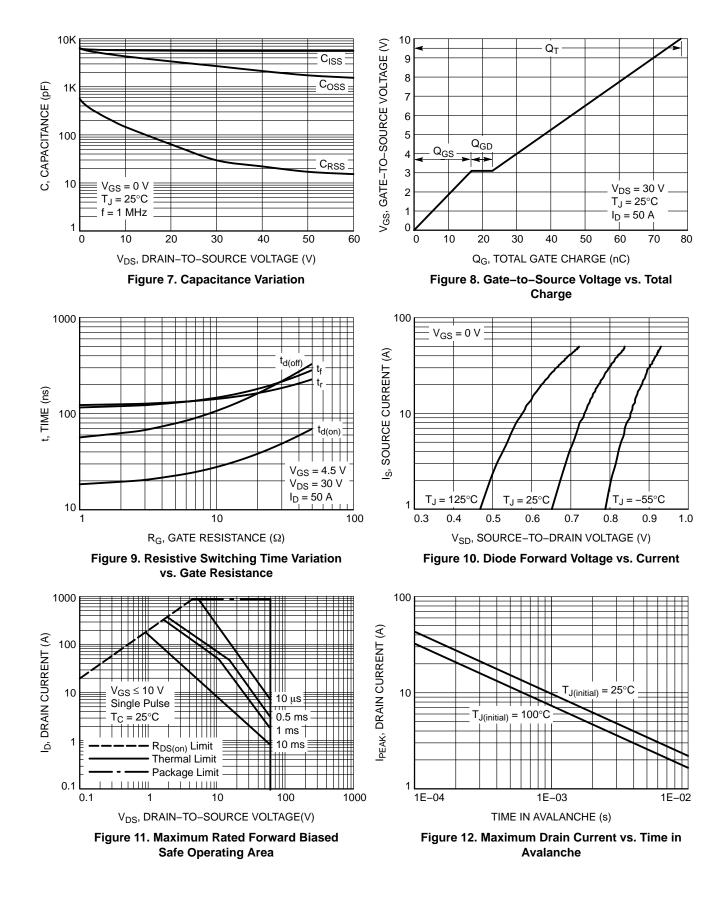
| Parameter | Symbol | Test Condition | | Min | Тур | Max | Unit |
|--|--|---|-------------------------|-----|------|-----|-------|
| OFF CHARACTERISTICS | | | | | | | |
| Drain-to-Source Breakdown Voltage | V _{(BR)DSS} | $V_{GS} = 0 V, I_D = 250 \mu A$ | | 60 | | | V |
| Drain-to-Source Breakdown Voltage Temperature Coefficient | V _{(BR)DSS} /T _J | | | | 24 | | mV/∘C |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{GS} = 0 V, V _{DS} = 60 V | $T_J = 25^{\circ}C$ | | | 10 | μΑ |
| | | | T _J = 125°C | | | 250 | |
| Gate-to-Source Leakage Current | I _{GSS} | $V_{DS} = 0 V, V_{GS}$ | _S = 20 V | | | 100 | nA |
| ON CHARACTERISTICS (Note 4) | | | | | | | |
| Gate Threshold Voltage | V _{GS(TH)} | $V_{GS} = V_{DS}, I_D =$ | = 250 μA | 1.2 | | 2.1 | V |
| Negative Threshold Temperature Coefficient | V _{GS(TH)} /T _J | | | | 5.8 | | mV/°C |
| Drain-to-Source On Resistance | R _{DS(on)} | V _{GS} = 10 V, I _D = 50 A | | | 2.1 | 2.5 | mΩ |
| | | V _{GS} = 4.5 V, I _E | ₀ = 50 A | | 2.7 | 3.4 | |
| Forward Transconductance | 9fs | $V_{DS} = 3 V, I_D$ | = 50 A | | 185 | | S |
| CHARGES, CAPACITANCES AND GATE RE | SISTANCES | | | | • | | 4 |
| Input Capacitance | C _{iss} | | | | 5700 | | pF |
| Output Capacitance | C _{oss} | $V_{GS} = 0 V, f = 2$ | | | 2800 | | 1 |
| Reverse Transfer Capacitance | C _{rss} | V _{DS} = 25 V | | | 36 | | - |
| Total Gate Charge | Q _{G(TOT)} | V _{DS} = 30 V, I _D = 50 A | V _{GS} = 4.5 V | | 34 | | nC |
| | | | V _{GS} = 10 V | | 78 | | |
| Total Gate Charge | Q _{G(TOT)} | V _{GS} = 4.5 V, V _{DS} = 30 V, I _D = 50 A | | | 34.0 | | nC |
| Threshold Gate Charge | Q _{G(TH)} | | | | 9.5 | | 1 |
| Gate-to-Source Charge | Q _{GS} | | | | 16.8 | | |
| Gate-to-Drain Charge | Q _{GD} | | | | 6.1 | | |
| Plateau Voltage | V _{GP} | | | | 3.1 | | V |
| Gate Resistance | R _G | | | | 0.7 | | Ω |
| SWITCHING CHARACTERISTICS (Note 5) | | | | | | | 1 |
| Turn–On Delay Time | t _{d(on)} | | | | 20 | | ns |
| Rise Time | t _r | V_{GS} = 4.5 V, V_{DS} = 30 V, I_{D} = 50 A, R_{G} = 2.5 Ω | | | 126 | | |
| Turn–Off Delay Time | t _{d(off)} | | | | 65 | | |
| Fall Time | t _f | | | | 121 | | |
| DRAIN-SOURCE DIODE CHARACTERISTIC | S | | | | | | |
| Forward Diode Voltage | ard Diode Voltage V_{SD} $V_{GS} = 0 V$, $I_S = 50 A$ | $V_{CS} = 0 V$ | $T_J = 25^{\circ}C$ | | 0.8 | 1.2 | V |
| | | T _J = 125°C | | 0.7 | | | |
| Reverse Recovery Time | t _{RR} | V _{GS} = 0 V, dI _S /dt = 100 A/μs, I _S = 50 A | | | 71 | | ns |
| Charge Time | ta | | | | 36 | | |
| Discharge Time | tb | | | | 36 | | |
| Reverse Recovery Charge | Q _{RR} | | | | 110 | | nC |

Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2%.
Switching characteristics are independent of operating junction temperatures.

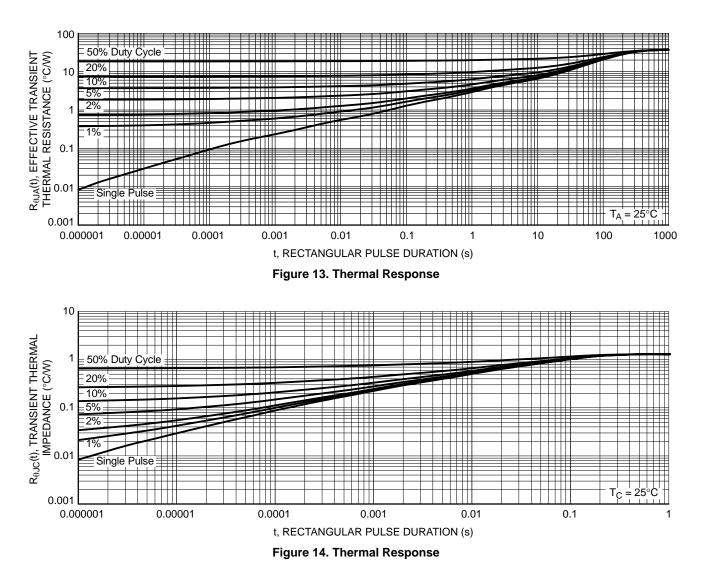
TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

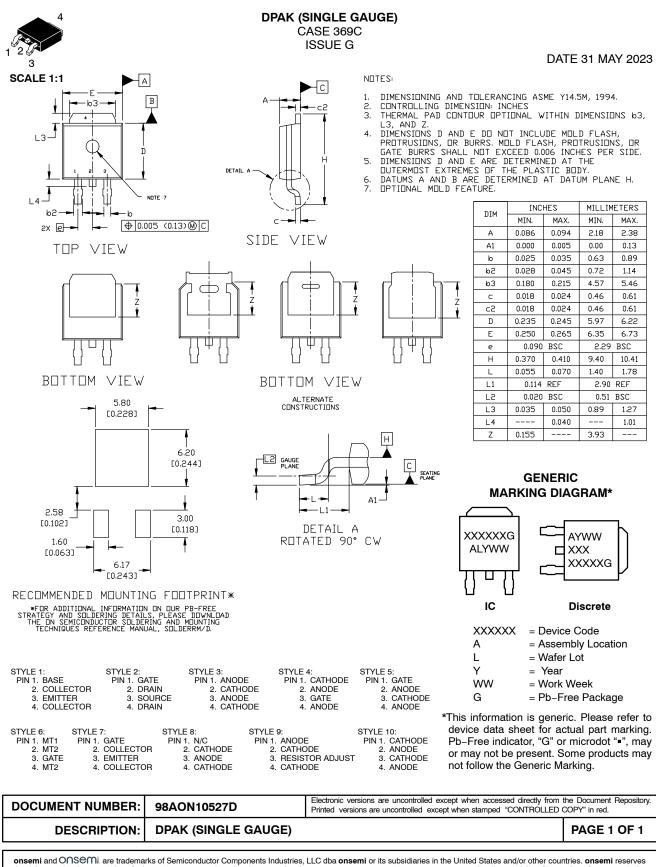


ORDERING INFORMATION

| Order Number | Package | Shipping [†] |
|---------------|-------------------|-----------------------|
| NTD5C632NLT4G | DPAK (Pb–Free) | 2500 / Tape & Reel |

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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